

05-14-2004

Form PTO-1595

(Rev. 10/02)

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U.S. DEPARTMENT OF COMMERCE
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OMB No. 0651-0027 (exp. 6/30/2005)

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To the Honorable Commissioner of Patents and Trademarks: Please record the attached original documents or copy thereof.

1. Name of conveying party(ies):

(1) Wei-Jung CHEN (5) Chien-Peng YU
(2) Yung-Ching CHANG
(3) Jaw-Shin HUANG
(4) Cheng-Yu FANGAdditional name(s) of conveying party(ies) attached? ☐ Yes ☒ No

3. Nature of conveyance:

☒ Assignment ☐ Merger
☐ Security Agreement ☐ Change of Name
☐ Other _____

Execution Date: 04/22/2004

2. Name and address of receiving party(ies)

Name: Advanced Analog Technology, Inc.

Internal Address: 2F, No. 17, Industry E. 2nd Rd
Science-Based Industrial Park, Hsinchu 300,
Taiwan

Street Address: Same as above

City: _____ State: _____ Zip: _____

Additional name(s) & address(es) attached? ☐ Yes ☒ No

4. Application number(s) or patent number(s):

If this document is being filed together with a new application, the execution date of the application is: 05/06/2004

A. Patent Application No.(s) _____

B. Patent No.(s) _____

Additional numbers attached? ☐ Yes ☒ No

5. Name and address of party to whom correspondence concerning document should be mailed:

Name: Raymond Y. CHAN

Internal Address: 108 N. Ynez Avenue, Suite 128

Monterey Park, CA 91754

Street Address: Same as above

City: _____ State: _____ Zip: _____

6. Total number of applications and patents involved: 1

7. Total fee (37 CFR 3.41).....\$ 40.00

☒ Enclosed☐ Authorized to be charged to deposit account

8. Deposit account number:

9. Signature.

Raymond Y. CHAN

Name of Person Signing

Signature

05/06/2004
Date

Total number of pages including cover sheet, attachments, and documents: 8

Mail documents to be recorded with required cover sheet information to:
Commissioner of Patents & Trademarks, Box Assignments
Washington, D.C. 20231

05/13/2004 NGETACHE 00000078 10841035

01 FC:0021

40.00 OP

PATENT
REEL: 015314 FRAME: 0646

ASSIGNMENT

WHEREAS, I (we), **Wei-Jung CHEN**
whose post office address(es) appear(s) below, hereinafter referred to as ASSIGNOR, have invented a
certain new and useful improvements in
Semiconductor Wafer and Manufacturing Process Thereof
(hereinafter referred to as the INVENTION) for which an application for United States Letters Patent
was

☒ executed on even data herewith
☐ executed on:
☐ filed on:

Serial No.:

WHEREAS, **Advanced Analog Technology, Inc**
whose post office address is **2F, No. 17, Industry E. 2nd Rd., Science-Based Industrial Park,**
Hsinchu 300, Taiwan
hereinafter referred to as ASSIGNEE, is desirous of acquiring the entire right, title and interest in and to
the same in the United States;

NOW, THEREFORE, for good and valuable consideration, receipt of which is hereby
acknowledged, I (we), ASSIGNOR, by these presents do sell, assign and transfer unto said ASSIGNEE,
the entire right, title, and interest in and to said INVENTION and application throughout the United
States of America, including any and all Letters Patent granted on any division, continuation,
continuation-in-part and reissue of said application.

ALSO, ASSIGNOR hereby agrees to execute any documents that legally may be required in
connection with the filing, prosecution and maintenance of said application or any other patent
application(s) in the United States for said INVENTION, including additional documents that may be
required to affirm the rights of ASSIGNEE in and to said INVENTION, all without further consideration.
ASSIGNOR also agrees, without further consideration and at ASSIGNEE'S expense, to identify and
communicate to ASSIGNEE at ASSIGNEE'S request documents and information concerning the
INVENTION that are within ASSIGNOR'S possession or control, and to provide further assurances and
testimony on behalf of ASSIGNEE that lawfully may be required of ASSIGNOR in respect of the
prosecution, maintenance and defense of any patent application or patent encompassed within the terms
of this instrument. ASSIGNOR'S obligations under this instrument shall extend to ASSIGNOR'S heirs,
executors, administrators and other legal representatives.

ALSO, ASSIGNOR hereby authorizes and requests the Commissioner of Patents and
Trademarks to issue any and all Letters Patent referred to above to ASSIGNEE, as the ASSIGNEE of the
entire right, title and interest in and to the same, for ASSIGNEE'S sole use and behoof; and for the use
and behoof of ASSIGNEE'S legal representatives and successors, to the full end of the term for which
such Letters Patent may be granted, as fully and entirely as the same would have been held by
ASSIGNOR had this assignment and sale not been made.

ASSIGNOR authorizes Raymond Yat Chiu Chan to insert or complete any information in this
document needed to effect its recordal in the U.S. Patent and Trademark Office.

ASSIGNOR NAME: **Wei-Jung CHEN**ADDRESS: **2F, No. 17, Industry E. 2nd Rd., Science-Based Industrial Park, Hsinchu 300,**
Taiwan
SIGNATURE
DATE

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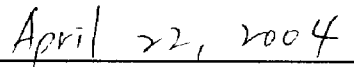
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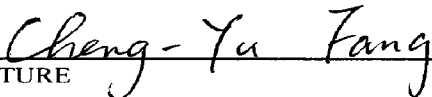
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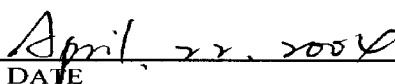
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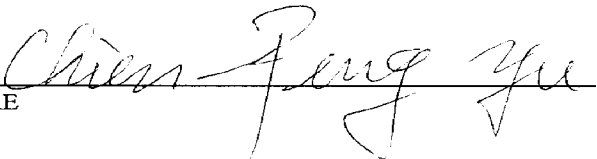
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